



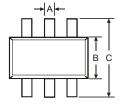
### SURFACE MOUNT SCHOTTKY BARRIER DIODE AR

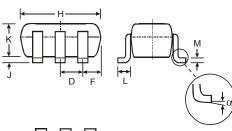
### **Features**

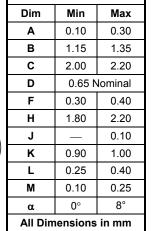
- Low Forward Voltage Drop
- Fast Switching
- Ultra-Small Surface Mount Package
- PN Junction Guard Ring for Transient and ESD Protection
- Lead Free/RoHS Compliant (Note 3)
- "Green" Device (Note 4 and 5)

### **Mechanical Data**

- Case: SOT-363
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe). Please see Ordering Information, Note 5, on Page 3
- Orientation: See Diagram
- Marking Information: K78, See Page 3
- Weight: 0.006 grams (approximate)







**SOT-363** 

C <sub>1</sub>		C <sub>2</sub>	
		<u>↑</u>	
■ A <sub>1</sub>	$\frac{1}{\Box}$	A <sub>2</sub>	

**TOP VIEW** 

between middle pins)

(Jumper

connection

# **Maximum Ratings** @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	70	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	49	V
Forward Continuous Current (Note 1)	I <sub>FM</sub>	70	mA
Non-Repetitive Peak Forward Surge Current @ t < 1.0s	I <sub>FSM</sub>	100	mA
Power Dissipation (Note 1)	P <sub>d</sub>	200	mW
Thermal Resistance Junction to Ambient Air (Note 1)	$R_{ heta JA}$	625	°C/W
Operating and Storage Temperature Range	T <sub>j</sub> T <sub>STG</sub>	-55 to +125 -65 to +125	°C

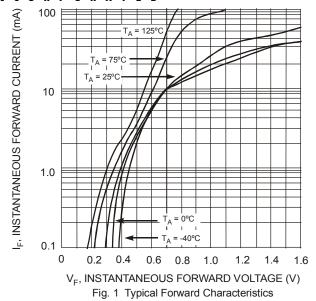
#### **Electrical Characteristics** @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 2)	$V_{(BR)R}$	70	_	V	$I_R = 10\mu A$
Forward Voltage	V <sub>F</sub>	_	410 1000	mV mV	$t_p < 300 \mu s$ , $I_F = 1.0 mA$ $t_p < 300 \mu s$ , $I_F = 15 mA$
Reverse Current (Note 2)	I <sub>R</sub>	_	100	nA	$t_p < 300 \mu s$ , $V_R = 50 V$
Total Capacitance	Ст	_	2.0	pF	V <sub>R</sub> = 0V, f = 1.0MHz
Reverse Recovery Time	t <sub>rr</sub>	_	5.0	ns	$I_F = I_R = 10 \text{mA} \text{ to } I_R = 1.0 \text{mA},$ $I_{rr} = 0.1 \text{ x } I_R, R_L = 100 \Omega$

Notes:

- Device mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
- Short duration pulse test used to minimize self-heating effect.
- No purposefully added lead.
- Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead\_free/index.php.
- Product manufactured with Date Code UO (week 40, 2007) and newer are built with Green Molding Compound. Product manufactured prior to Date Code UO are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.





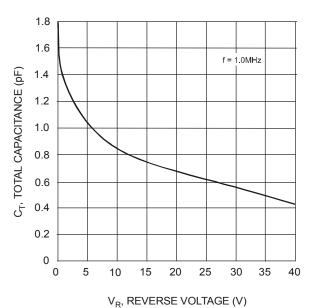
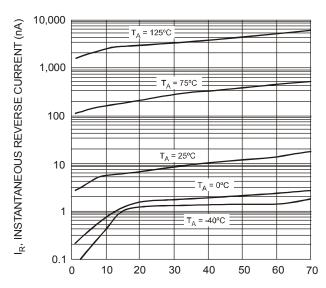
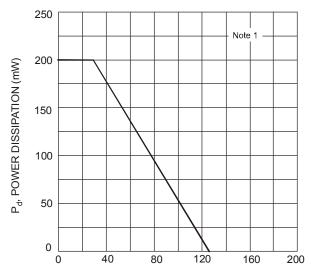


Fig. 3 Typical Capacitance



 $V_R$ , REVERSE VOLTAGE (V) Fig. 2 Typical Reverse Characteristics



 ${\rm T_{A}}$ , AMBIENT TEMPERATURE (°C) Fig. 4 Power Derating Curve, Total Package



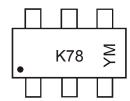
## Ordering Information (Note 6 & 7)

Device	Packaging	Shipping
BAS70JW-7-F	SOT-363	3000/Tape & Reel

Notes:

- 6. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.
- 7. For Lead Free/RoHS Compliant version part number, please add "-F" suffix to the part number above. Example: BAS70JW-7-F.

# **Marking Information**



K78 = Product Type Marking Code YM = Date Code Marking Y = Year ex: N = 2002 M = Month ex: 9 = September

Year	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012
Code	М	N	Р	R	S	Т	U	V	W	Х	Υ	Z

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

#### IMPORTANT NOTICE

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to any product herein. Diodes Incorporated does not assume any liability arising out of the application or use of any product described herein; neither does it convey any license under its patent rights, nor the rights of others. The user of products in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on our website, harmless against all damages.

### LIFE SUPPORT

Diodes Incorporated products are not authorized for use as critical components in life support devices or systems without the expressed written approval of the President of Diodes Incorporated.